

Cree® XLamp® XP-C LEDs Data Sheet

The XLamp XP-C LED combines the proven lighting-class performance and reliability of the XLamp XR-E LED in a package with 80% smaller footprint. The XLamp XP-C LED continues Cree's history of innovation in LEDs for lighting applications with wide viewing angle, symmetrical package, unlimited floor life and electrically neutral thermal path.

Cree XLamp LEDs bring high performance and quality of light to a wide range of lighting applications, including color-changing lighting, portable and personal lighting, outdoor lighting, indoor directional lighting, commercial lighting and emergency-vehicle lighting.



FEATURES

- Available in white (2,600 K to 10,000 K CCT)
- Maximum drive current: up to 500 mA
- Low thermal resistance: 12 °C/W
- Wide viewing angle: 110°
- Unlimited floor life at \leq 30 °C/85% RH
- Reflow solderable JEDEC J-STD-020C compatible
- Electrically neutral thermal path
- RoHS-compliant

Table of Contents

Flux Characteristics (T, = 25°C)	2
Characteristics Relative Spectral Power Distribution	2
Relative Spectral Power Distribution Relative Flux vs. Junction Temperature ($I_F = 350$ mA)	
Electrical Characteristics $(T_j = 25^{\circ}C)$	4
Thermal Design	4
Relative Flux vs. Current ($T_1 = 25^{\circ}C$)	5
Typical Spatial Distribution.	5
Reflow Soldering Characteristics Notes	6
Mechanical Dimensions ($T_A = 25^{\circ}$ C) Tape and Reel	8
Tape and Reel	9
Packaging	10



Flux Characteristics (T₁ = 25°C)

The following table provides several base order codes for XLamp XP-C LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XP-E & XP-C Binning and Labeling document.

Color	CCT Range		Base Order Codes Min Luminous Flux (Im)		Order Code	
	Min.	Max.	Group	Flux (lm)		
	ool White 5,000 K	К 10,000 К	P3	73.9	XPCWHT-L1-0000-00801	
Caal White			P4	80.6	XPCWHT-L1-0000-00901	
Cool white			Q2	87.4	XPCWHT-L1-0000-00A01	
			Q3	93.9	XPCWHT-L1-0000-00B01	
		00 К 5,000 К	P2	67.2	XPCWHT-L1-0000-007E4	
Neutral White	3,700 K		P3	73.9	XPCWHT-L1-0000-008E4	
			P4	80.6	XPCWHT-L1-0000-009E4	
		К 3,700 К	N3	56.8	XPCWHT-L1-0000-005E7	
Warm White	2,600 K		N4	62.0	XPCWHT-L1-0000-006E7	
			P2	67.2	XPCWHT-L1-0000-007E7	

Notes:

- Cree maintains a tolerance of +/- 7% on flux and power measurements.
- Typical CRI for Cool White & Neutral White (3,700 K 10,000 K CCT) is 75.
- Typical CRI for Warm White (2,600 K 3,700 K CCT) is 80.

Characteristics

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point	°C/W		12	
Viewing angle (FWHM)	degrees		110	
Temperature coefficient of voltage	mV/°C		-4.0	
ESD classification (HBM per Mil-Std-883D)			Class 2	
DC forward current	mA			500
Reverse voltage	V			5
Forward voltage (@ 350 mA)	V		3.4	3.9
Forward voltage (@ 500 mA)	V		3.5	
LED junction temperature	°C			150

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Relative Spectral Power Distribution



Relative Flux vs. Junction Temperature ($I_F = 350 \text{ mA}$)



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Electrical Characteristics $(T_1 = 25^{\circ}C)$



Thermal Design

The maximum forward current is determined by the thermal resistance between the LED junction and ambient. Given an existing thermal resistance of 12 °C/W between the junction and the solder point, it is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.



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Relative Flux vs. Current $(T_1 = 25^{\circ}C)$



Typical Spatial Distribution



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Reflow Soldering Characteristics

In testing, Cree has found XLamp XP-C LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of solder paste used.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



Lead-Based Solder Lead-Free Solder **Profile Feature** Average Ramp-Up Rate (Ts_{max} to Tp) 3°C/second max. 3°C/second max. Preheat: Temperature Min (Ts_{min}) 100°C 150°C Preheat: Temperature Max (Ts_{max}) 150°C 200°C Preheat: Time (ts_{min} to ts_{max}) 60-120 seconds 60-180 seconds Time Maintained Above: Temperature (T,) 183°C 217°C Time Maintained Above: Time (t,) 60-150 seconds 60-150 seconds Peak/Classification Temperature (Tp) 215°C 260°C Time Within 5°C of Actual Peak Temperature (tp) 10-30 seconds 20-40 seconds Ramp-Down Rate 6°C/second max. 6°C/second max Time 25°C to Peak Temperature 6 minutes max. 8 minutes max.

Note: All temperatures refer to topside of the package, measured on the package body surface.



Notes

Moisture Sensitivity

In testing, Cree has found XLamp XP-C & XP-E LEDs to have unlimited floor life in conditions \leq 30°C / 85% relative humidity (RH). Moisture testing included a 168 hour soak at 85°C / 85% RH followed by 3 reflow cycles, with visual and electrical inspections at each stage.

RoHS Compliance

The levels of environmentally sensitive, persistent biologically toxic (PBT), persistent organic pollutants (POP), or otherwise restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2002/95/EC on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS), as amended through April 21, 2006.

Vision Advisory Claim

Users should be cautioned not to stare at the light of this LED product. The bright light can damage the eye.



<u>Mechanical Dimensions ($T_A = 25^{\circ}C$)</u>

All measurements are \pm .13 mm unless otherwise indicated.











Top View

Side View

Bottom View



RECOMMENDED PCB SOLDER PAD



RECOMMENDED STENCIL PATTERN (HATCHED AREA IS OPENING)

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Tape and Reel





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Packaging

All dimensions in mm.

